

## On the Mechanism of Niobium Electropolishing: Some effects of Gravity and Geometry

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#### Motivation

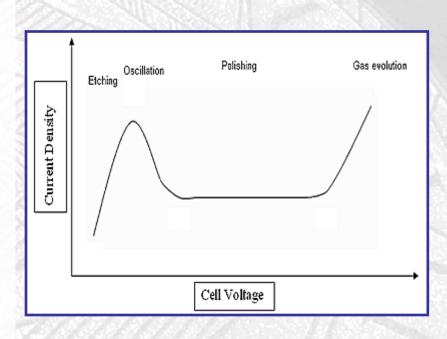
- Surface defects like pits, protrusions, and grain boundaries are detrimental to the performance of SRF cavities
- Electropolishing is so far the best technique to get a high quality surface finish
- The electropolishing mechanism for niobium is not very well understood, specially the association of pits with the EBW region
- Interesting to look at the <u>interface between pure</u> <u>electrochemistry</u>, and its realization in cavity work





### Electropolishing Fundamentals

- EP occurs when the metal surface of interest is made anodic (+) in an appropriate solution
- The surface roughness of the finish is much less than that achieved with mechanical polishing
- The I-V (polarization) curve has etching, oscillation, plateau, and gas evolution regions, EP is carried out in the plateau region
- The current density plateau is observed because of mass transport limitation



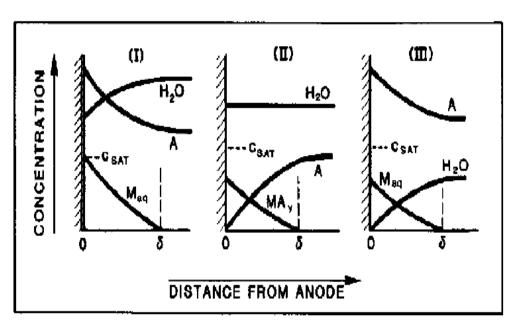
A typical electropolishing polarization curve





#### Possible Mechanisms

#### Possible mass transport mechanisms<sup>1</sup>



$$i_L = nFD(C_s - C_b)/\delta$$

i<sub>I</sub> = Limiting current density

D = Diffusion coefficient of species involved

 $C_s$  = Surface conc

 $C_h = Bulk conc$ 

Salt film metal ion saturation

Water Acceptor ion transport transport limitation limitation

1. D.Landolt, Electrochimica Acta, 32,1 (1987)

**Department of Materials Science & Engineering** 







#### Probable Reactions Occurring at the Electrodes

## At Working Electrode:

Travel to counter electrode and react with e- from Al to form H

Travel to (1) Nb oxidizes circuit via

species

(2) HF reacts with oxide to give Nb-F

$$2 \text{ Nb} + 5 \text{ H}_2\text{O} \rightarrow \text{Nb}_2\text{O}_5 + 10 \text{ H}^+ + 10 \text{e}^-$$

$$Nb_2O_5 + HF \longrightarrow H_2NbOF_5 + HNbF_6 + NbF_5 + 3 H_2O$$

$$NbF_{5} + (SO_{3}, H_{2}O) \longrightarrow NbF_{3}(SO_{3}F)_{2} . 2H_{2}O + Nb_{2}O(SO_{4})_{4} + S_{2}O_{5}F_{2}$$

$$+ \text{sulfuric}$$
react

Niobium is oxidized to niobium oxide which then dissolves to form niobium fluoride, oxofluoride species, fluorosulfate, oxysulfate and pyrosulfurylfluoride in the presence of sulfuric acid and hydrofluoric acid.

#### At Counter Electrode:

$$2 H^{+} + 2e^{-} \longrightarrow H_{2}$$

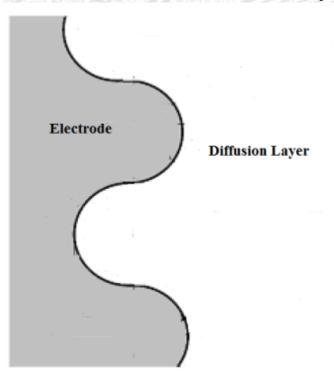
F.Eozenou, A.Aspart, C.Antoine, and B.Maliki, CARE Report 06-10-SRF. EU Contract number RII3-CT-2003-506395





### **Electropolishing Effect**

In any case, the current flow difference in thick and thin areas causes the polishing occur



$$i_L = nFD(C_s - C_b)/\delta$$

**Bulk Electrolyte** 

- •Diffusion layer thickness ( $\delta$ ) is different over protrusions and valleys.
- •Dissolution current density over protrusions is higher than in valley, resulting in leveling effect



#### Our Schematic Bath for Nb EP

- Working Electrode: High purity polycrystalline Nb (99.999%)
- Counter Electrode: High purity AI (99.99%)
- Reference Electrode: mercurous sulfate electrode (MSE)
- Electrolyte: HF(48%)+
   H<sub>2</sub>SO<sub>4</sub>(96%) in 1:9 vol ratio

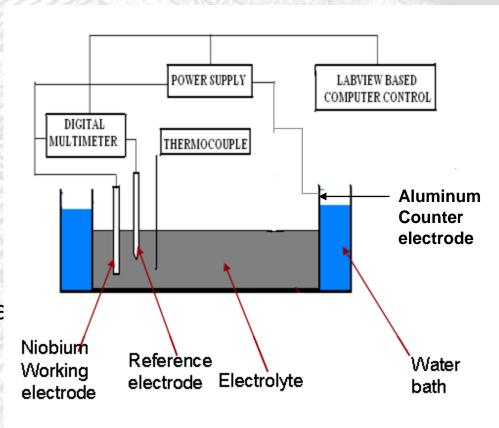


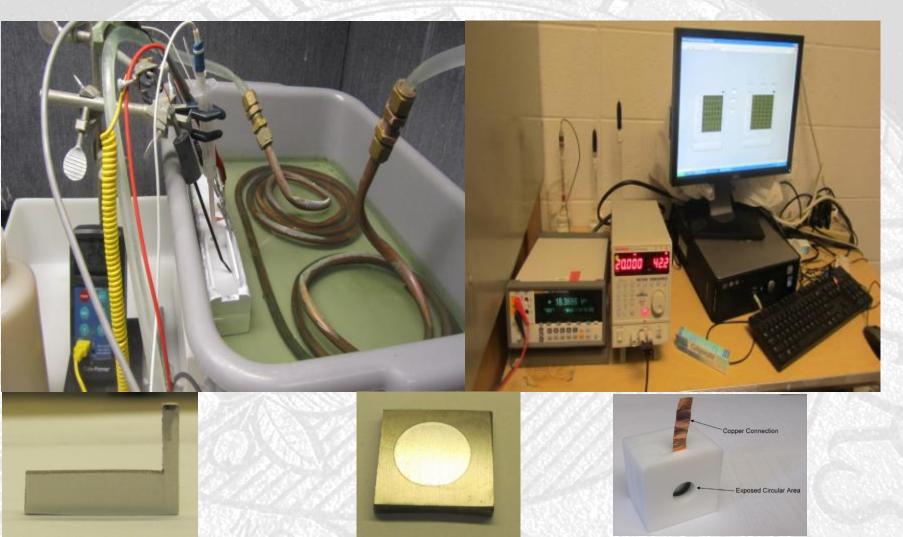
Fig: Schematic of the experimental setup.





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### **Experimental Setup**



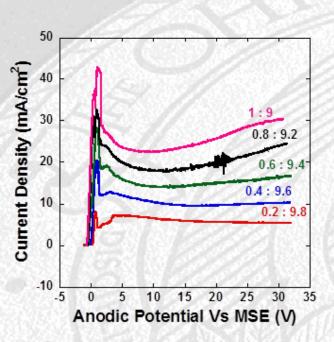
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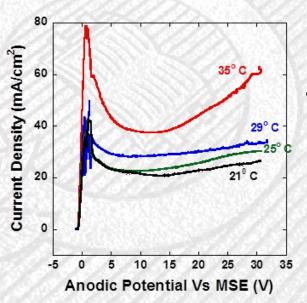
# Replicating Acid Ratio/Temperature, and stirring results in our set-up



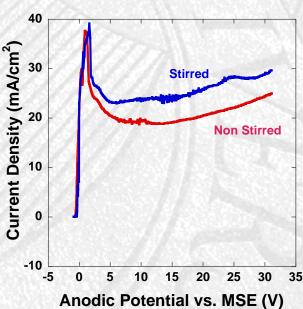
Effect of HF:H2SO4 ratio

By know well known effect of acid ratios, T, and agitation

Effect of temperature



Effect of bath agitation



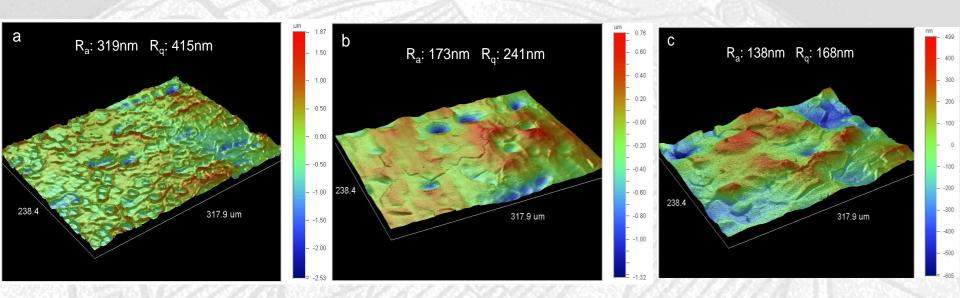
Note: Effect of [F-] supports acceptor limited model





# Verification of Evolution of surface roughness with EP time

V= 15V, T= 26C, HF: $H_2SO_4 \rightarrow 1:9$ 



EP time: 2 h EP time: 4 h EP time: 6 h

Surface changes from scalloped appearance after 2 h of electropolishing to a relatively smoother surface after 6 h of polishing.

A novel approach to characterizing the surface topography of niobium superconducting radio frequency (SRF) accelerator cavities
Hui Tiana,b, Guilhem Ribeill a,c, Chen Xub, Charles E. Reecea, Michael J. Kelleya,b,\*

PHYSICAL REVIEW SPECIAL TOPICS - ACCELERATORS AND BEAMS 14, 123501 (2011)

Enhanced characterization of niobium surface topography

Chen Xu, 1,2 Hui Tian, 1 Charles E. Reece, 1 and Michael J. Kelley 1,2

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# Fluorine diffusion limited mass transport control

What's controlling process?

Proceedings of PAC09, Vancouver, BC, Canada

WE5PFP058

#### BASIC ELECTROPOLISHING PROCESS RESEARCH AND DEVELOPMENT IN SUPPORT OF IMPROVED RELIABLE PERFORMANCE SRF CAVITIES FOR THE FUTURE ACCELRATORS

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<sup>\*</sup>Applied Science Dept., College of William and Mary, Williamsburg, VA 23185, U.S.A.

PHYSICAL REVIEW SPECIAL TOPICS - ACCELERATORS AND BEAMS 13, 083502 (2010)

Evaluation of the diffusion coefficient of fluorine during the electropolishing of niobium

Hui Tian\* and Charles E. Reece

Thomas Jefferson National Accelerator Facility, Newport News, Virginia 23606, USA (Received 30 November 2009; published 25 August 2010)

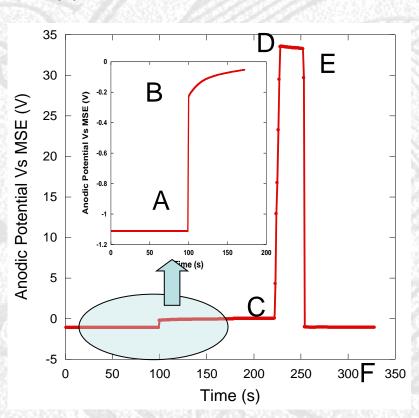




#### **Potential Transients**

Galvanostatic experiments help identify EP mechanism.

#### Application of Current at or Above Limiting Current Density Value



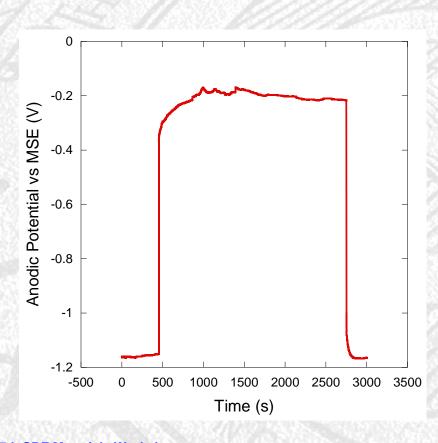
- Current switched on at A and switched off at E
- AB: Ohmic overpotential and rapid charging of double layer
- BC: Activation and concentration overpotential
- CD: Potential spike due to fluoride ion concentration going to zero at electrode surface





#### **Potential Transient**

#### Application of Current Below Limiting Current Density Value



- Huge spike in potential not obtained.
- Fluoride ion concentration at surface does not fall to zero.



## Potential Transients to Identify the Mechanism Involved

 Sand's equation describes time to reach a particular surface concentration for semi-infinite 1-D diffusion:

$$\sqrt{\tau} = \frac{nF}{2i} C_{acceptor}^{o} \sqrt{\pi D_{acceptor}}$$

τ - transient time at which potential spikes

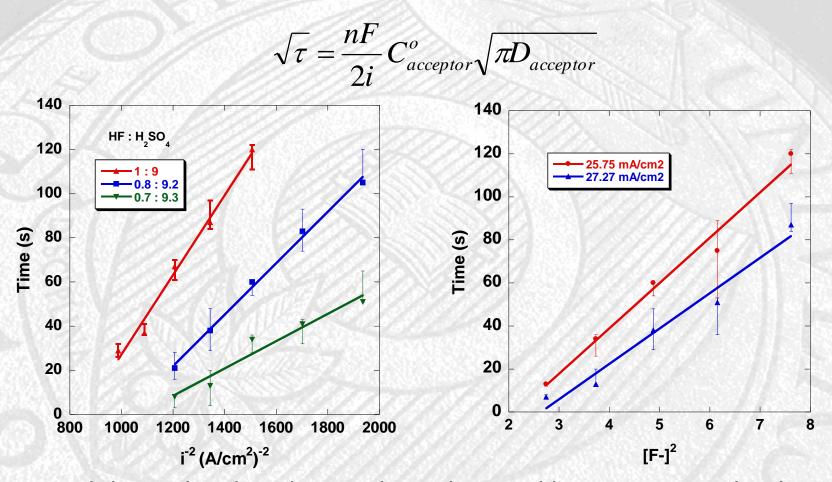
Coacceptor - concentration of acceptor species in bulk electrolyte

D<sub>acceptor</sub> - diffusion coefficient of acceptor species





## Effect of Current Density and Acceptor Ion Concentration on the Induction Time



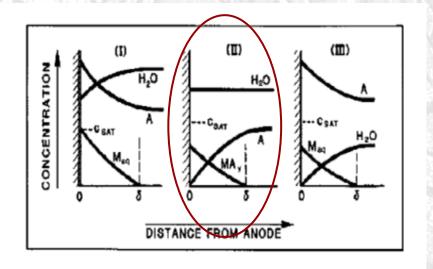
Expected dependencies observed consistent with acceptor mechanism





# Evidence of Possible Gravity-driven Convective Effects

- Visual evidence of some form of viscous layer formation.
- Bluish-green colored layer which vanishes as soon as the power supply is turned off.







## Evidence of the presence of surface film while Niobium electropolishing

- A mass transport limited current plateau is necessary for electropolishing to take place
- There are evidences of some form of film formation on the surface through which there is diffusion limited transport of ions involved in polishing mechanism
- The surface film formed is soluble and dissolves in the electrolyte on switching off the current



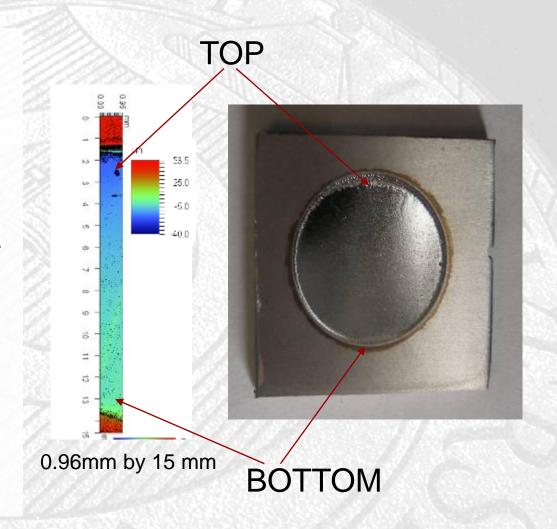
Surface Film formed during electropolishing





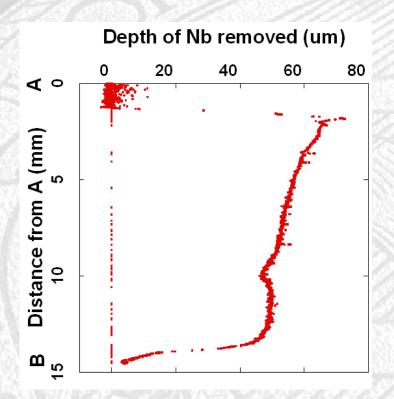
## Evidence of the presence of surface film while niobium electropolishing

- There is an effect of gravity on the film
- Thinner film at the top of the sample because of hydrodynamics
- Higher dissolution rate at the top of the sample





## Evidence of Possible Gravity-Convective Effects



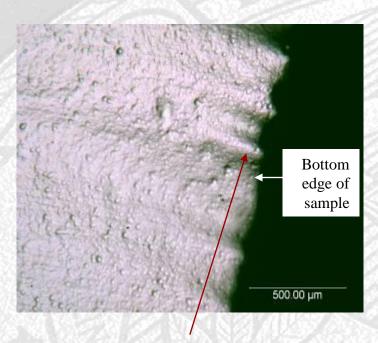


 Natural, gravity driven convection results in thinner diffusion layer at top of sample, hence higher dissolution rate

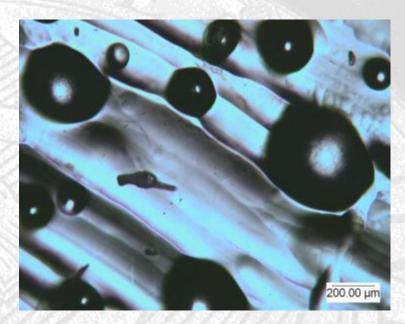




#### **Evidence of Possible Convective Effects**



Ridges close to bottom edge of sample due to convection caused by dissolution products (sliding of the film under gravity)



- Pits at surface of flag electrode that was facing down.
- Possibly: Gravity + convection of film prevented the formation of a stable film and hence pitting instead of electropolishing
- Selective dissolution resulted in pitting



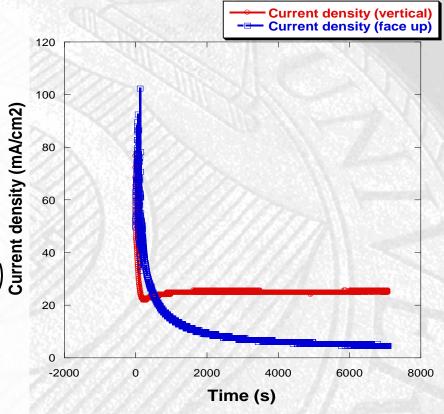


#### Surface film, gravity, convective effects and EP rate for EP "face up" and vertical Flag

- EP rate should depend on film thickness
- Film is weakly held on and may
- The EP bath on top softom surfaces, respectively

  The face up configuration (blue) had a very low current density and polishing rate (thick film)

  The vertical configuration is a relatively him is sity and points.



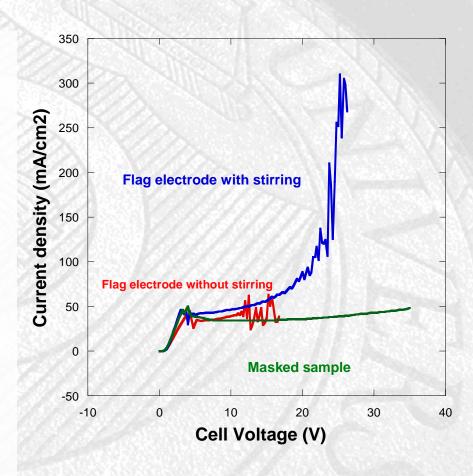
I vs t for EP done at 15V for 2 hours at 26°C





## Surface film and polarization curve instability ("noise") during niobium electropolishing of <u>VERTICAL</u> flag

- Film thickness increases with the applied potential till it falls under its own weight
- Formation and re-dissolution of the film causes current oscillation – may well be chaotic (in the physics sense)
- Stirring causes the film to remain thin, weight could be supported till relatively higher potential
- No oscillations in case of electropolishing of masked sample due to controlled hydrodynamics at the surface

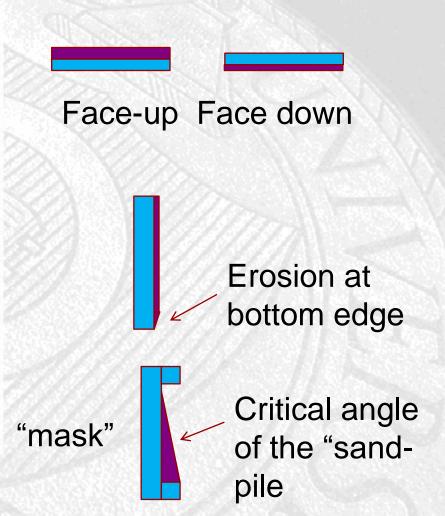






## Surface (viscous) film, gravity, and EP rate for EP "face up" and "face down"

- Assume weakly adhering surface film
- Gravity assist in "face up" mode leads to thick films
- Gravity "attack" in "face down" mode leads to thin films
- Un-masked vertical films may show preferential attack at bottom edges
- Masked vertical films extra support for film at bottom edge







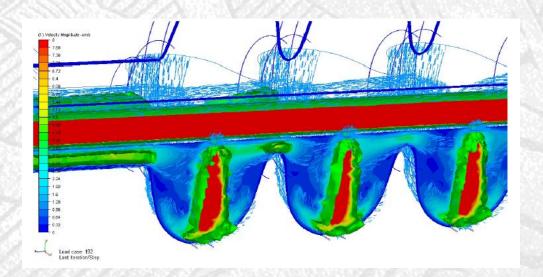
# How will this play out in a cavity as it is polished?

 Will topology of the surface be an issue in any gravity and convection moderated effects?

## HYDRODYNAMIC THERMAL MODELING OF 9-CELL ILC CAVITY ELECTROPOLISHING AND IMPLICATIONS FOR IMPROVING THE EP PROCESS \*

Charles E. Reece<sup>#</sup>, Jun Ortega<sup>‡</sup>, and John Mammosser<sup>†</sup>
Thomas Jefferson National Accelerator Facility, Newport News, VA 23606

<sup>‡</sup>Blue Ridge Numerics, Charlottesville, VA 22911





### **Summary-Conclusions**

- Set up made for EP under very controlled temperature conditions
- Standard Temperature, acid, surface roughness results demonstrated with our set-up
- Galvanostatic experiments suggest that mechanism controlling EP of Nb is transport of fluoride ions to surface.
- Natural convection and gravity effects seem to be present how important are these?





### Ongoing work

- EP for Nb samples with welds
- As-received and samples with weld bump removed
- Samples of both types in different orientations and convection conditions to investigate possible film/gravity effects
- Localized EP across the welded regions and the HAZ

